ICS83056I





GENERAL DESCRIPTION



The ICS83056I is a low skew, 6:1, Single-ended Multiplexer and a member of the HiPerClockS™ family of High Performance Clock Solutions from ICS. The ICS83056I has six selectable single-ended clock inputs and one single-ended clock

output. The output has a V_{DDO} pin which may be set at 3.3V, 2.5V, or 1.8V, making the device ideal for use in voltage translation applications. An output enable pin places the output in a high impedance state which may be useful for testing or debug. The device operates up to 250MHz and is packaged in a 16 TSSOP.

FEATURES

- 6:1 single-ended multiplexer
- Q nominal output impedance: $7\Omega (V_{DDO} = 3.3V)$
- Maximum output frequency: 250MHz
- Propagation delay: 3ns (maximum), V_{DD} = V_{DDO} = 3.3V
- Input skew: 225ps (maximum), $V_{DD} = V_{DDO} = 3.3V$
- Part-to-part skew: 475ps (maximum), V_{DD} = V_{DDO} = 3.3V
- · Operating supply modes:

 V_{DD}/V_{DDO} 3.3V/3.3V

3.3V/2.5V

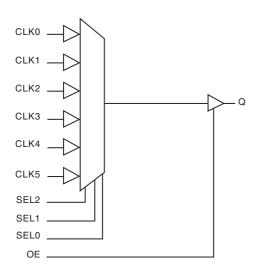
3.3V/1.8V

2.5V/2.5V

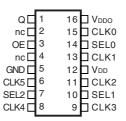
2.5V/1.8V

- -40°C to 85°C ambient operating temperature
- Available in both standard and lead-free RoHS-compliant packages

BLOCK DIAGRAM



PIN ASSIGNMENT



ICS83056I 16-LeadTSSOP 4.4mm x 5.0mm x 0.92mm package body G Package

Top View



TABLE 1. PIN DESCRIPTIONS

Number	Name	Ty	/ре	Description
1	Q	Output		Single-ended clock output. LVCMOS/LVTTL interface levels.
2, 4	nc	Unused		No connect.
6, 8, 9, 11, 13, 15	CLK5, CLK4, CLK3, CLK2, CLK1, CLK0	Input	Pulldown	Single-ended clock inputs. LVCMOS/LVTTL interface levels.
3	OE	Input	Pullup	Output enable. When LOW, outputs are in HIGH impedance state. When HIGH, outputs are active. LVCMOS / LVTTL interface levels.
5	GND	Power		Power supply ground.
7, 10, 14	SEL2, SEL1, SEL0	Input	Pulldown	Clock select input. See Control Input Function Table. LVCMOS / LVTTL interface levels.
12	V _{DD}	Power		Core and input supply pin.
16	V _{DDO}	Power		Output supply pin.

NOTE: Pullup and Pulldown refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance			4		pF
R _{PULLUP}	Input Pullup Resistor			51		kΩ
R _{PULLDOWN}	Input Pulldown Resistor			51		kΩ
	Power Dissipation Capacitance (per output)	$V_{DDO} = 3.465V$		18		рF
C _{PD}		V _{DDO} = 2.625V		20		рF
		V _{DDO} = 1.89V		30		рF
	Output Impedance	$V_{DDO} = 3.465V$		7		Ω
R _{OUT}		V _{DDO} = 2.625V		7		Ω
		V _{DDO} = 1.89V		10		Ω

TABLE 3. CONTROL INPUT FUNCTION TABLE

	Control Inputs		Input Selected to Q
SEL2	SEL1	SEL0	input Selected to Q
0	0	0	CLK0
0	0	1	CLK1
0	1	0	CLK2
0	1	1	CLK3
1	0	0	CLK4
1	0	1	CLK5
1	1	0	LOW
1	1	1	LOW

ICS83056I





ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD} 4.6V

 $\begin{array}{ll} \text{Inputs, V}_{\text{I}} & -0.5 \text{V to V}_{\text{DD}} + 0.5 \text{ V} \\ \\ \text{Outputs, V}_{\text{O}} & -0.5 \text{V to V}_{\text{DDO}} + 0.5 \text{V} \\ \\ \text{Package Thermal Impedance, } \theta_{\text{JA}} & 89 ^{\circ}\text{C/W (0 lfpm)} \end{array}$

Storage Temperature, T_{STG} -65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Table 4A. Power Supply DC Characteristics, $V_{DD} = V_{DDO} = 3.3V \pm 5\%$, Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{DD}	Core Supply Voltage		3.135	3.3	3.465	V
V _{DDO}	Output Supply Voltage		3.135	3.3	3.465	V
I _{DD}	Power Supply Current				40	mA
I _{DDO}	Output Supply Current				5	mA

$\textbf{Table 4B. Power Supply DC Characteristics, } V_{\text{DD}} = 3.3 \text{V} \pm 5\%, V_{\text{DDO}} = 2.5 \text{V} \pm 5\%, T_{\text{A}} = -40 ^{\circ}\text{C} \text{ to } 85 ^{\circ}\text{C}$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{DD}	Core Supply Voltage		3.135	3.3	3.465	V
V _{DDO}	Output Supply Voltage		2.375	2.5	2.625	V
I _{DD}	Power Supply Current				40	mA
I _{DDO}	Output Supply Current				5	mA

Table 4C. Power Supply DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{DD}	Core Supply Voltage		3.135	3.3	3.465	V
V _{DDO}	Output Supply Voltage		1.71	1.8	1.89	V
I _{DD}	Power Supply Current				40	mA
I _{DDO}	Output Supply Current				5	mA

Table 4D. Power Supply DC Characteristics, $V_{DD} = V_{DDO} = 2.5V \pm 5\%$, Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{DD}	Core Supply Voltage		2.375	2.5	2.625	V
V _{DDO}	Output Supply Voltage		2.375	2.5	2.625	V
I _{DD}	Power Supply Current				35	mA
I _{DDO}	Output Supply Current				5	mA

Table 4E. Power Supply DC Characteristics, $V_{DD} = 2.5V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{DD}	Core Supply Voltage		2.375	2.5	2.625	V
V _{DDO}	Output Supply Voltage		1.71	1.8	1.89	V
I _{DD}	Power Supply Current				35	mA
I _{DDO}	Output Supply Current				5	mA



TABLE 4F. LVCMOS/LVTTL DC CHARACTERISTICS, TA = -40°C TO 85°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V	Input High Voltage		$V_{DD} = 3.3V \pm 5\%$	2		V _{DD} + 0.3	V
V _{IH}	Input High Voltage		$V_{DD} = 2.5V \pm 5\%$	1.7		V _{DD} + 0.3	V
\/	Input Low Voltage		$V_{DD} = 3.3V \pm 5\%$	-0.3		0.8	V
V _{IL}	Input Low Voltage		$V_{DD} = 2.5V \pm 5\%$	-0.3		0.7	V
I _{IH} Input High Current	CLK0:CLK5, SEL0:SEL2	$V_{DD} = 3.3V \text{ or } 2.5V \pm 5\%$			150	μΑ	
		OE	$V_{DD} = 3.3V \text{ or } 2.5V \pm 5\%$			5	μΑ
I _L	Input Low Current	CLK0:CLK5, SEL0:SEL2	$V_{DD} = 3.3V \text{ or } 2.5V \pm 5\%$	-5			μA
IL.	'	OE	$V_{DD} = 3.3V \text{ or } 2.5V \pm 5\%$	-150			μΑ
			$V_{DDO} = 3.3V \pm 5\%$; NOTE 1	2.6			V
V _{OH}	Output HighVoltage		$V_{DDO} = 2.5V \pm 5\%$; NOTE 1	1.8			V
			$V_{DDO} = 1.8V \pm 5\%$; NOTE 1	V _{DD} - 0.3			V
			$V_{DDO} = 3.3V \pm 5\%$; NOTE 1			0.5	V
V _{OL}	Output Low Voltage		$V_{DDO} = 2.5V \pm 5\%$; NOTE 1			0.45	٧
			$V_{DDO} = 1.8V \pm 5\%$; NOTE 1			0.35	V

NOTE 1: Outputs terminated with 50Ω to $V_{DDO}/2$. See Parameter Measurement section, "Load Test Circuit" diagrams.

Table 5A. AC Characteristics, $V_{DD} = V_{DDO} = 3.3V \pm 5\%$, Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequency				250	MHz
tp _{LH}	Propagation Delay, Low to High; NOTE 1		2.4	2.7	3.0	ns
tp _{HL}	Propagation Delay, High to Low; NOTE 1		2.5	2.7	2.9	ns
tsk(i)	Input Skew; NOTE 2			55	225	ps
tsk(pp)	Part-to-Part Skew; NOTE 2, 3				475	ps
t _R / t _F	Output Rise/Fall Time	20% to 80%	50		500	ps
odc	Output Duty Cycle		45		55	%
MUX _{ISOL}	MUX Isolation	@ 100MHz		45		dB

NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DDO}/2$ of the output. NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Defined as skew between outputs on different devices operating a the same supply voltages and with equal load conditions. Using the same type of input on each device, the output is measured at $V_{\rm npo}/2$.



Table 5B. AC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 2.5V \pm 5\%$, Ta = -40°C to 85° C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequency				250	MHz
tp _{LH}	Propagation Delay, Low to High; NOTE 1		2.5	2.8	3.1	ns
tp _{HL}	Propagation Delay, High to Low; NOTE 1		2.6	2.8	3.0	ns
tsk(i)	Input Skew; NOTE 2			45	150	ps
tsk(pp)	Part-to-Part Skew; NOTE 2, 3				400	ps
t _R / t _F	Output Rise/Fall Time	20% to 80%	50		500	ps
odc	Output Duty Cycle		45		55	%
MUX _{ISOL}	MUX Isolation	@ 100MHz		45		dB

NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DDO}/2$ of the output.

NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Defined as skew between outputs on different devices operating a the same supply voltages and with equal load conditions. Using the same type of input on each device, the output is measured at V_{nnd}/2.

Table 5C. AC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequency				250	MHz
tp _{LH}	Propagation Delay, Low to High; NOTE 1		2.7	3.2	3.8	ns
tp _{HL}	Propagation Delay, High to Low; NOTE 1		2.8	3.3	3.8	ns
tsk(i)	Input Skew; NOTE 2			50	150	ps
tsk(pp)	Part-to-Part Skew; NOTE 2, 3				475	ps
t _R / t _F	Output Rise/Fall Time	20% to 80%	100		700	ps
odc	Output Duty Cycle		45		55	%
MUX _{ISOL}	MUX Isolation	@ 100MHz		45		dB

NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DDO}/2$ of the output. NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Defined as skew between outputs on different devices operating a the same supply voltages and with equal load conditions. Using the same type of input on each device, the output is measured at V_{nno}/2.



Table 5D. AC Characteristics, $V_{DD} = V_{DDO} = 2.5V \pm 5\%$, Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequency				250	MHz
tp _{LH}	Propagation Delay, Low to High; NOTE 1		2.5	3.0	3.5	ns
tp _{HL}	Propagation Delay, High to Low; NOTE 1		2.5	2.9	3.4	ns
tsk(i)	Input Skew; NOTE 2			60	175	ps
tsk(pp)	Part-to-Part Skew; NOTE 2, 3				300	ps
t _R / t _F	Output Rise/Fall Time	20% to 80%	100		500	ps
odc	Output Duty Cycle		40		60	%
MUX _{ISOL}	MUX Isolation	@ 100MHz		45		dB

NOTE 1: Measured from $V_{\rm DD}/2$ of the input to $V_{\rm DDO}/2$ of the output.

NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Defined as skew between outputs on different devices operating a the same supply voltages and with equal load conditions. Using the same type of input on each device, the output is measured at $V_{\rm DDO}/2$.

Table 5E. AC Characteristics, V_{DD} = 2.5V \pm 5%, V_{DDO} = 1.8V \pm -0.2V, Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequency				250	MHz
tp _{LH}	Propagation Delay, Low to High; NOTE 1		2.6	3.3	4.0	ns
tp _{HL}	Propagation Delay, High to Low; NOTE 1		2.7	3.3	4.0	ns
tsk(i)	Input Skew; NOTE 2			50	150	ps
tsk(pp)	Part-to-Part Skew; NOTE 2, 3				325	ps
t _R / t _F	Output Rise/Fall Time	20% to 80%	100		700	ps
odc	Output Duty Cycle		40		60	%
MUX _{ISOL}	MUX Isolation	@ 100MHz		45		dB

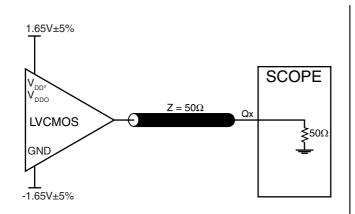
NOTE 1: Measured from $V_{\rm DD}/2$ of the input to $V_{\rm DDO}/2$ of the output.

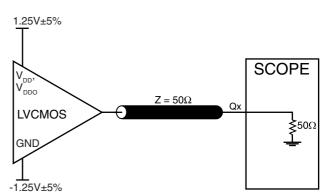
NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Defined as skew between outputs on different devices operating a the same supply voltages and with equal load conditions. Using the same type of input on each device, the output is measured at $V_{\rm DDO}/2$.



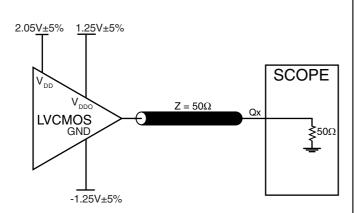
PARAMETER MEASUREMENT INFORMATION

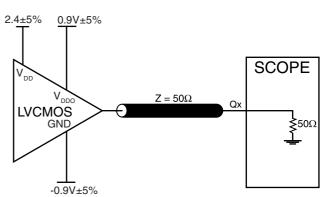




3.3V CORE/3.3V OUTPUT LOAD AC TEST CIRCUIT

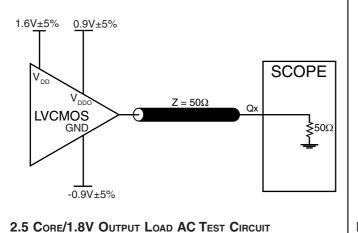
2.5V CORE/2.5V OUTPUT LOAD AC TEST CIRCUIT

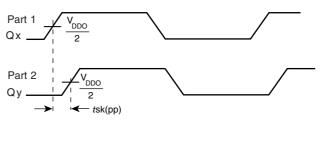




3.3V CORE/2.5V OUTPUT LOAD AC TEST CIRCUIT

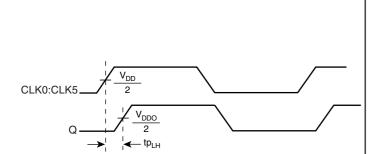
3.3V CORE/1.8V OUTPUT LOAD AC TEST CIRCUIT

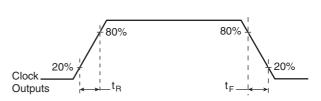




PART-TO-PART SKEW

ICS83056I 6:1, Single-Ended Multiplexer

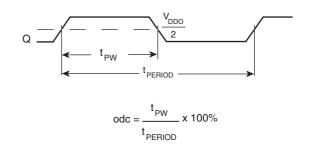




PROPAGATION DELAY

CLKy $tsk(i) = \left| t_{PD2} - t_{PD1} \right|$

OUTPUT RISE/FALLTIME



INPUT SKEW

OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD



APPLICATION INFORMATION

RECOMMENDATIONS FOR UNUSED INPUT PINS

INPUTS:

CLK INPUT:

For applications not requiring the use of a clock input, it can be left floating. Though not required, but for additional protection, a 1kW resistor can be tied from the CLK input to ground.

LVCMOS CONTROL PINS:

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A $1k\Omega$ resistor can be used.



RELIABILITY INFORMATION

Table 6. $\theta_{JA} vs.$ Air Flow Table for 16 Lead TSSOP

θ_{AA} by Velocity (Linear Feet per Minute)

 0
 200
 500

 Single-Layer PCB, JEDEC Standard Test Boards
 137.1°C/W
 118.2°C/W
 106.8°C/W

 Multi-Layer PCB, JEDEC Standard Test Boards
 89.0°C/W
 81.8°C/W
 78.1°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS83056I is: 874



PACKAGE OUTLINE - G SUFFIX FOR 16 LEAD TSSOP

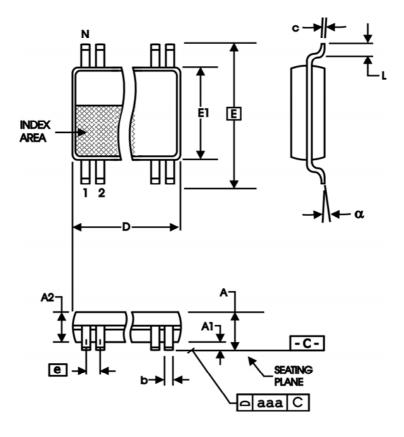


TABLE 7. PACKAGE DIMENSIONS

SYMBOL	Millimeters		
STWIDOL	Minimum	Maximum	
N	1	6	
Α		1.20	
A1	0.05	0.15	
A2	0.80	1.05	
b	0.19	0.30	
С	0.09	0.20	
D	4.90	5.10	
E	6.40 E	BASIC	
E1	4.30	4.50	
е	0.65 E	BASIC	
L	0.45	0.75	
α	0°	8°	
aaa		0.10	

Reference Document: JEDEC Publication 95, MO-153



ICS83056I

6:1, SINGLE-ENDED MULTIPLEXER

Table 8. Ordering Information

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS83056AGI	83056AGI	16 Lead TSSOP	tube	-40°C to 85°C
ICS83056AGIT	83056AGI	16 Lead TSSOP	2500 tape & reel	-40°C to 85°C
ICS83056AGILF	83056AIL	16 Lead "Lead-Free" TSSOP	tube	-40°C to 85°C
ICS83056AGILFT	83056AIL	16 Lead "Lead-Free" TSSOP	2500 tape & reel	-40°C to 85°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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Integrated Circuit Systems, Inc.

ICS83056I 6:1, Single-Ended Multiplexer

REVISION HISTORY SHEET				
Rev	Table	Page	Description of Change	Date
Α	Т8	12	Ordering Information Table - added Lead-Free marking.	1/18/06